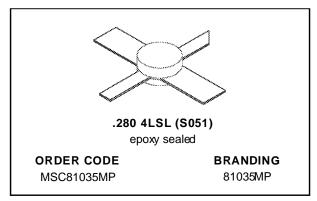


MSC81035MP

RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- ∞:1 VSWR CAPABILITY
- LOW THERMAL RESISTANCE
- INPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- Pout = 35 W MIN. WITH 10.7 dB GAIN

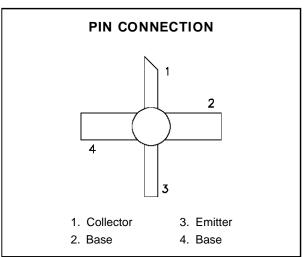


DESCRIPTION

The MSC81035MP is a medium power Class C transistor designed specifically for pulsed L-Band avionics applications. This device is a direct replacement for the MSC1035MP. MSC81035MP offers improved saturated ouput power and collector efficiency based on the test circuit described herein.

Low RF thermal resistance and computerized automatic wire bonding techniques ensure high reliability and product consistency.

The MSC81035MP is housed in the IMPAC™ package with internal input matching.



ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit	
Poiss	Power Dissipation* (T _C ≤ 100°C)	150	W	
Ic	Device Current*	3.0	А	
V _{CC}	Collector-Supply Voltage*	55	V	
TJ	Junction Temperature (Pulsed RF Operation)	250	°C	
T _{STG}	Storage Temperature	- 65 to +150	°C	

THERMAL DATA

R _{TH(j-c)}	Junction-Case Thermal Resistance*	1.0	°C/W

*Applies only to rated RF amplifier operation

Note: Thermal Resistance determined by Infra-Red Scanning of Hot-Spot Junction Temperature at rated RF operating conditions.

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ELECTRICAL SPECIFICATIONS (T_{case} = 25°C)

STATIC

Symbol	Test Conditions	Value			Unit		
		Min.	Тур.	Max.			
BV _{CBO}	I _C = 10mA	$I_E = 0mA$		65	_		V
BV _{EBO}	I _E = 1mA	$I_C = 0mA$		3.5	_	_	V
BV _{CER}	IC = 10mA	$R_{BE} = 10\Omega$		65	_		V
Ices	V _{BE} = 0V	$V_{CE} = 50V$			_	5	mA
h _{FE}	V _{CE} = 5V	I _C = 500mA		15	_	120	_

DYNAMIC

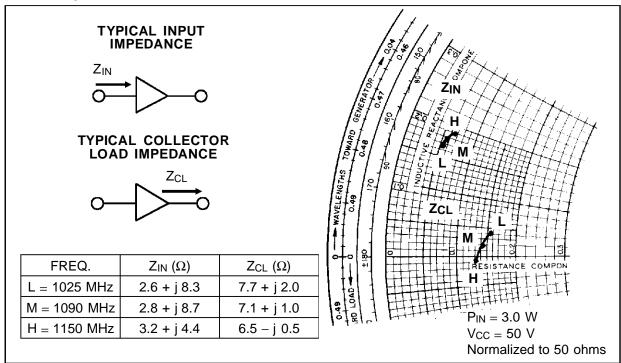
Symbol	Test Conditions		Value			IIm:4
Symbol			Min.	Тур.	Max.	Unit
Pout	f = 1025 — 1150 MHz P _{IN} = 3.0W	$V_{CC} = 50V$	35	40		W
ης	f = 1025 — 1150 MHz P _{IN} = 3.0W	$V_{CC} = 50V$	10.7	11.2	_	%
G _P	f = 1025 — 1150 MHz P _{IN} = 3.0W	$V_{CC} = 50V$	43	48	_	dB

Note: Pulse Width = $10\mu Sec$ Duty Cycle = 1%

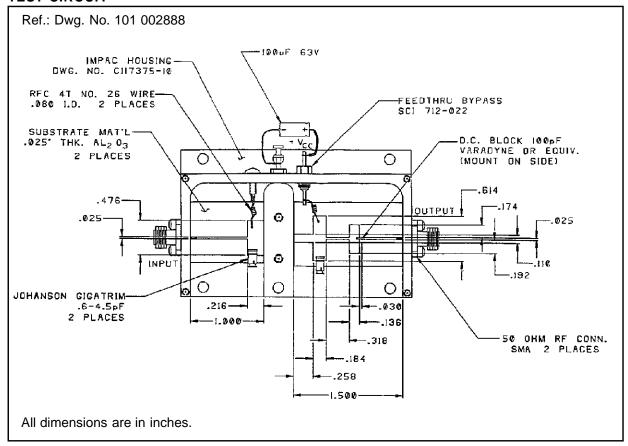
TYPICAL PERFORMANCE

TYPICAL BROADBAND POWER AMPLIFIER (MATIS) Pin = 3W Pin = 3W 1025 FREQUENCY (MHz)

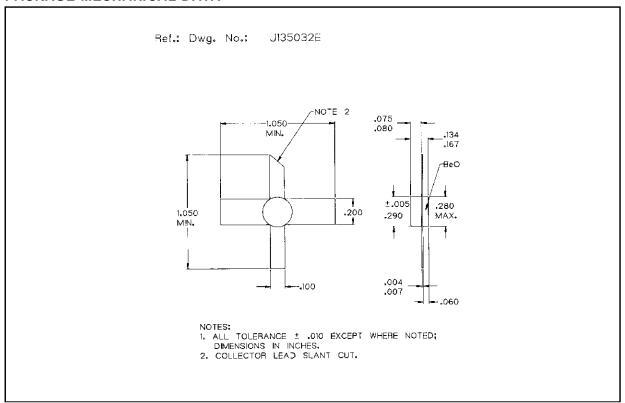
IMPEDANCE DATA



TEST CIRCUIT



PACKAGE MECHANICAL DATA



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